

R&D Activities @ IMB-CNM for the DRD3



Giulio Pellegrini

On behalf of the RDG



Ecosystem

PRUAB Spin-off Incubator



**Universitat
Autònoma
de Barcelona**

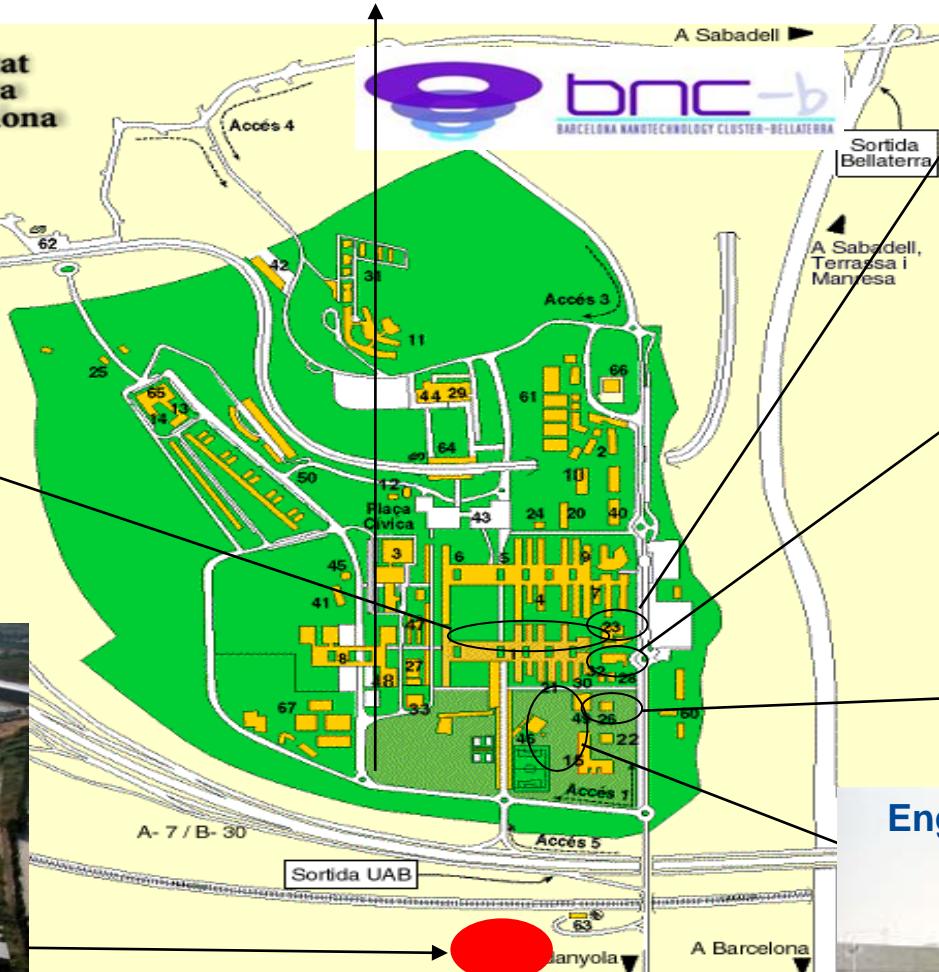
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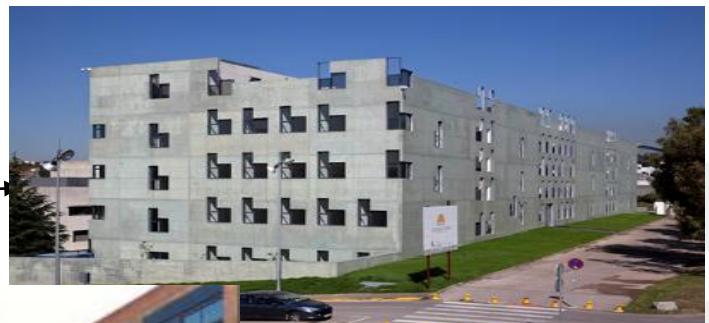
Sciences (UAB)



Alba Synchrotron



Materials Science Institute (CSIC)



Engineering

ICN2

Clean Room

1500 m²

total area

190

equipment units

3000

Wafers/year

550

Runs/year

40

staff

40

self service

2500

Hours self service

450

registered self service
licenses

**Largest R&D Clean
Room in Spain**



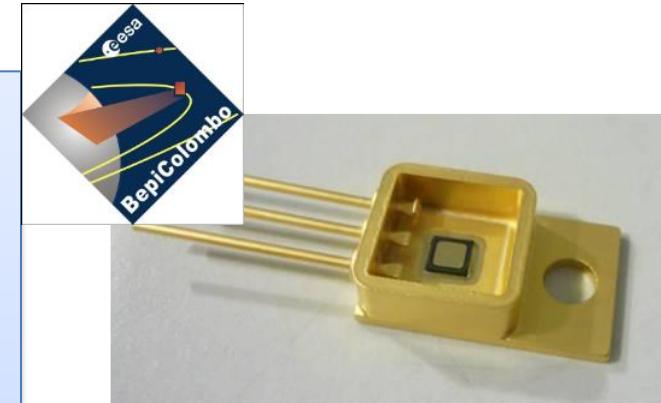
The main activities of IMB-CNM is basic and applied research and development, education and training in micro and nanotechnologies, components and systems.

[Clean room virtual tour](#)

Experience in production

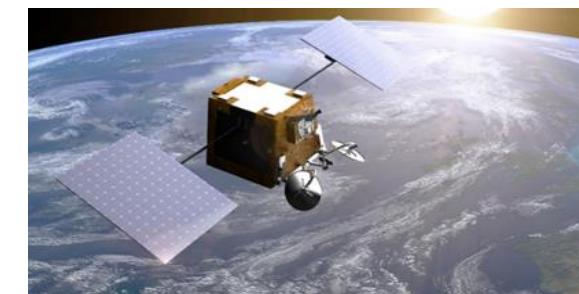
SiC rectifiers for space

Bepi-Colombo & Solar orbiter missions
Main contractors EADS, Airbus, ALTER
400k€/year (2,800 k€ accumulated)



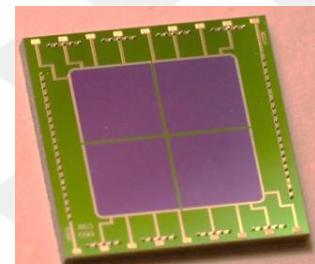
Chemical sensors ISFETs type

Main contractors: AlphaMOS & Devicare-global Health Home Devices
120k€/year.



Radiation detectors and dummies.

Main contractor CERN (ATLAS, CMS, RD50, TOTEM) for HEP.
Other contractors: Argonne, INFN, BNL, DESY, GSI, Xian University, Amsterdam scientific, for Nuclear Physics and other applications.



Four Quadrant diodes for space

OneWeb constellation. Airbus and SolarMems.
In orbit since February 2019, full contract 650 k€

Radiation Detector Group (RDG)

Senior researchers

1. Giulio Pellegrini, Head of the group
2. Manuel Lozano Fantoba,
3. Miguel Ullan Comes,
4. Maria Celeste Fleta Corral,
5. Joan Marc Rafi Tatjer,
6. Enric Cabruja Casas,
7. Esteve Amat Bertran, *this year*
8. Consuelo Guardiola Salmeron, *this year*
9. Gianluigi Casse 2023

10. Salvador Hidalgo (PDS group)
11. David Flores (PDS group)
12. Angel Merlos (GTQ group)

Postdocs

1. Daniela Bassignana (D+T project manager)
2. Ivan Lopez Paz
3. Maria Manna
4. Neil Moffat,
5. Martín Pérez, Marie Curie Fell., 2023

Technician

1. Vainius Dauderys,
2. Francisco Javier Bravo Calvo,
3. Luis Figueras (2023)

High internationalization, 36% foreigners.

Phd students

1. Eric Bach Marques,
2. Oscar David Ferrer Naval,
3. Marcio Alfonso Jimenez Venegas,
4. Carla Riera Llobet,
5. Milos Manojlovic,
6. Jairo Antonio Villegas Dominguez,
7. New FPI, 2023.



*+ Erasmus, Master, grade students,
visiting PhDs.*

Technological area in DRD3

Resources (FTE per year) [2024 to 2028]

Technological area in DRD3	Permanent [FTE/year]	Temporary [FTE/year]
• Monolithic CMOS sensors	0	1
• Sensors for tracking and calorimetry with space, time and/or energy resolution [4D, 3D, trench detectors, modelling, simulation, ...]	2	2
• Radiation damage & ultrahigh fluences [Defect characterization, TCAD and other damage simulations, irradiation tests, ...]	0.5	2
• New characterization techniques and facilities of common interest [Irradiation and test beam facilities, IBIC, laser testing, ..]	0.5	0.5
• Non-silicon semiconductor and other material studies [Diamond, SiC, GaN, WBG, ..]	1.	1
• Interconnect and device fabrication technologies [3D integration, TSV, reduction of pitches, wafer bonding technologies,..]	0.5	1
• Dissemination and outreach	0.5	0

National and EU projects related to DRD3

1. Detectores para las mejoras de atlas para el HL-LHC, PID2021-124660OB-C22.
2. Construcción de los sensores de strip del ITK de ATLAS y desarrollo de las tecnologías para los sensores de los futuros experimentos, PID2021-126327OB-C22.
3. Actividades del IMB-CNM para los “upgrades” de alta luminosidad del Inner Tracker y EndCap Timing Layer (CMSUPG) (PID2020-113705RB-C32).
4. Detectores de avalancha de baja ganancia de rayos-x blandos con pitch de 55um para aplicaciones de imagen empleando el ASIC TIMEPIX4, PID2020-118275RB-C22.

1. Development of particle detectors based on silicon-carbide devices, Contract with Austrian Academy of Sciences.
2. Advancement and Innovation for Detectors at Accelerators (AidalInnova), EU 101004761.
3. Different projects from RD50 common funding.

1. Optimización y fabricación de sensores LGAD para el demostrador tecnológico de un tomógrafo de muones con resolución temporal (TOMULGAD) (PDC2021-121718-C32).
2. Micro detectores 3d para estudio de terapia FLASH, PDC2022-133120-C21

FPA

International

Proof of concept

Other funding (EU and national) related to DRD3

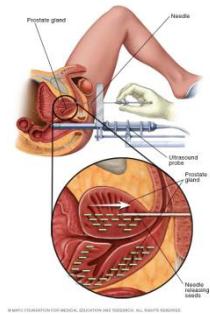
1. Metrology for Advanced radiotherapy using particle beams with ultra-high pulse close rates (UHDpulse)
EU18HLT04.
2. Future Oriented Renewable and Reliable Energy SiC Solutions, EU 101075672 (Coordination).
3. An interoperable multidomain CBRN system, EU 101018596.
4. THz Wave Accelerating Cavity for ultrafast science, EU TWAC (101046504).
5. Marie Curie Fellowship > 2023

EU projects

1. Technology developments of solid-state detectors for advanced dosimetry" (NEWDOSI) , PID2021-123484OB-I00 .
2. Detectores de neutrones ultra delgados para haces pulsados, SUBV-8 /2022.
3. Microdetectors for medical applications, 20225AT008
4. RDG financiado por la Generalitat de Cataluña, AGAUR, Generalitat de Cataluña. Grupo calidad 2023.
5. PIACeD: Planar All-Carbon electrode Diamond detector for radiotherapy (CNM internal project)
6. Un microchip muy grande, FCT-21-16975.

National

Collaborations



Brachytherapy



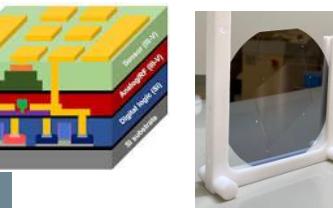
Soft X-ray imaging



- DMAPS simulation
- Timing and 3D
- 2D materials

Single Photon Detectors
for Quantum Imaging

- Innovative LGAD technologies
- Ultra radiation hard silicon
- SiC testing.



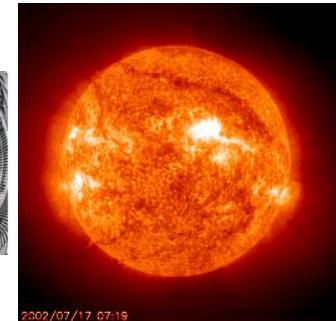
3D system integration



- WBG materials (SiC, GaN, Diamond)
- Irradiation studies



- Medipix 4 (LGADs and 3D)



Fusion

Radiotherapy
9

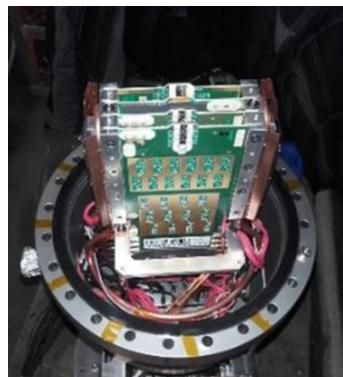
Technologies developed within the RD50 collaboration

Strong involvement since the start of the collaboration.

Main technological breakthrough in radiation detectors used in experiments.



TOTEM CT-PPS
is the first CERN
experiment
using LGAD
proposed and
fabricated at
CNM!

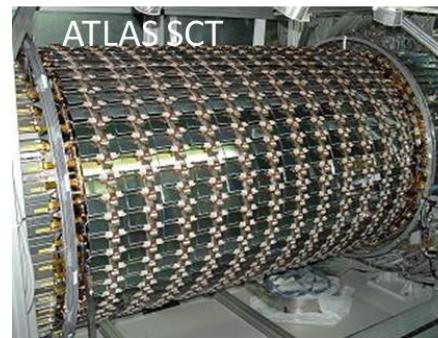


P-type strip
detectors

Alibaba
systems

3D double
sided

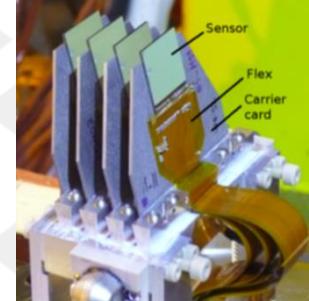
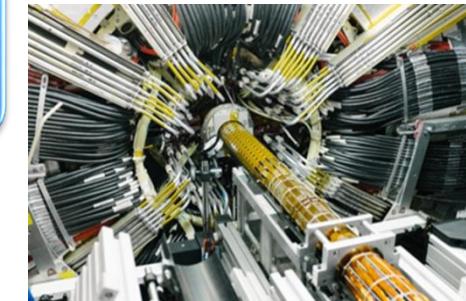
LGAD
technology



Supported the early
development of this
technology.



Atlas IBL



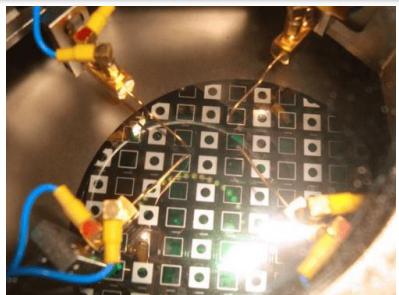
First DS3D at IMB-CNM

Infrastructures available at IMB-CNM

- **Clean room facility**
- **RDG Laboratory**



- Steady-state electrical characterization setup
- Cascade probe station with thermal chuck (-70° to 210°C)
- Transient Current Technique (TCT), UV, blue and infrared lasers.
- CCE setup for timing (mip particles).
- Alibava System: Portable readout system for radiation detectors
- X-ray tube for irradiation and imaging.



Clean room

- class 100 to 10.000
- Technologies for Micro y Nano fabrication
- 3 Areas:
 - ✓ CMOS (high purity, no contaminants)
 - ✓ MNC (Noble Metals contaminants for Si)
 - ✓ Nanolithography
- Process size: 4" and 6" wafers.
- Technologies: CMOS, MEMS/NEMS, power devices, radiation detectors
- Silicon + WBG (SiC, GaN, Diamond).
- Silicon Micromachining
- ISO9001 in progress (2023)

Microelectronic Packaging Area

- 200 m², class 100
- Wafer cutting, wire-bonding, bump-bonding

Future Plans (involvement in the DRD3)

DMAPS

We are interested in working on the simulation of DMAPS in collaboration with other institutes within the DRD3 collaboration. The IMB-CNM group is expert in Sentaurus simulation toolkit and has a large experience in the technology of CMOS devices

4D tracking

Continue to develop, through simulation and fabrication, innovative solid state sensors with 4D-capabilities for tracking applications based on the different LGAD technologies (iLGAD, n-LGAD, AC-LGAD, etc..) and 3D detectors.

Radiation damage & ultrahigh fluence

Develop new detector in innovative materials (SiC, GaN, Diamond, 2D materials) to operate at extreme fluences and study the performance of combined TCAD-simulated electric fields with Geant4 (G4) simulations.

Interconnection

The development of advanced hybrid and 3D integration techniques at IMB-CNM. Improving the UBM layer deposition technology and the development of 3D stacking techniques like Through Silicon Vias (TSV), stitching, or bonding technologies.

Dissemination and outreach

We are interested to provide training events at our institutions on simulation and microelectronic fabrication in the framework of a Master program.

Thank you for your attention

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Barcelona · Spain

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